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866

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

20/03/24
01/08/02

APPL NUM 10043724	FILING DATE 01/08/2002	CLASS 438	SUBCLASS 2842	GAU 2842	EXAMINER H. Lee
**APPLICANTS: Lee Kang-Yoon;					
**CONTINUING DATA VERIFIED: NONE Lee					
** FOREIGN APPLICATIONS VERIFIED: Lee REPUBLIC OF KOREA 01-1892 01/12/2001 Yes					
PG-PUB <input type="checkbox"/>		DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>	
Foreign priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials Lee				ATTORNEY DOCKET NO 9898-201	
TITLE : Method of forming semiconductor device having contact pad on source/drain region in peripheral circuit area					

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg. Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner	
		PREPARED FOR ISSUE	
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